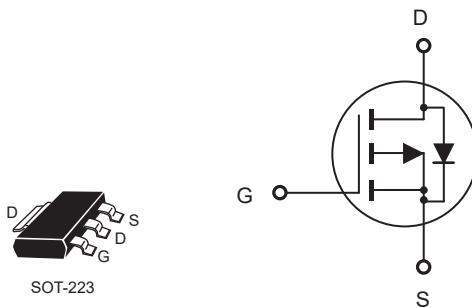


P-Channel Enhancement Mode Field Effect Transistor

FEATURES

- -30V, -10A, $R_{DS(ON)} = 19m\Omega$ @ $V_{GS} = -10V$.
 $R_{DS(ON)} = 29m\Omega$ @ $V_{GS} = -4.5V$.
- High dense cell design for extremely low $R_{DS(ON)}$.
- Rugged and reliable.
- RoHS compliant.
- SOT-223 package.



ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 25	V
Drain Current-Continuous	I_D	-10	A
Drain Current-Pulsed ^a	I_{DM}	-40	A
Maximum Power Dissipation	P_D	2.98	W
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Ambient ^b	$R_{\theta JA}$	42	$^\circ C/W$



CET3133

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
On Characteristics^c						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = -250\mu\text{A}$	-0.8		-2	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -10\text{V}, I_D = -4\text{A}$		15	19	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -2\text{A}$		22	29	$\text{m}\Omega$
Dynamic Characteristics^d						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		1710		pF
Output Capacitance	C_{oss}			260		pF
Reverse Transfer Capacitance	C_{rss}			185		pF
Switching Characteristics^d						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = -24\text{V}, I_D = -1\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$		16		ns
Turn-On Rise Time	t_r			8		ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			75		ns
Turn-Off Fall Time	t_f			36		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = -24\text{V}, I_D = -1\text{A}, V_{\text{GS}} = -4.5\text{V}$		18		nC
Gate-Source Charge	Q_{gs}			3.4		nC
Gate-Drain Charge	Q_{gd}			7.1		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S				-2.4	A
Drain-Source Diode Forward Voltage ^c	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = -2\text{A}$			-1.2	V
Notes :						
a Repetitive Rating : Pulse width limited by maximum junction temperature.						
b.Surface Mounted on FR4 Board, $t \leq 10$ sec.						
c.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.						
d.Guaranteed by design, not subject to production testing.						

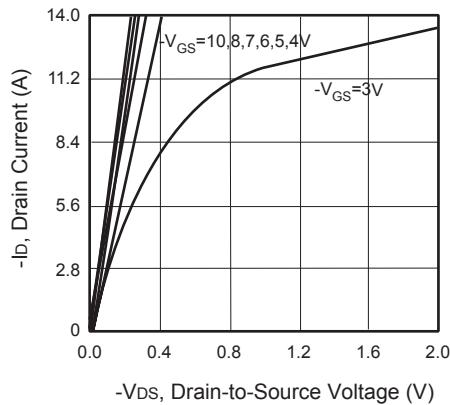
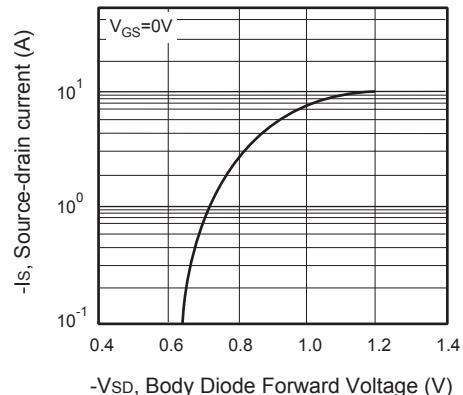
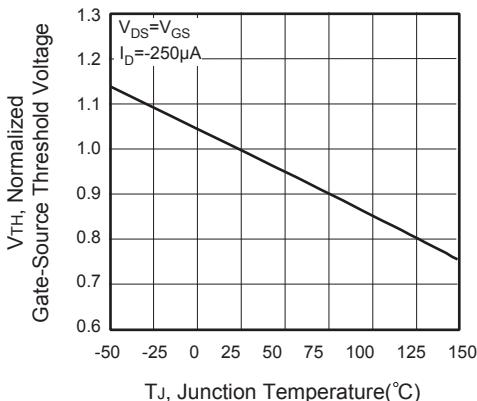
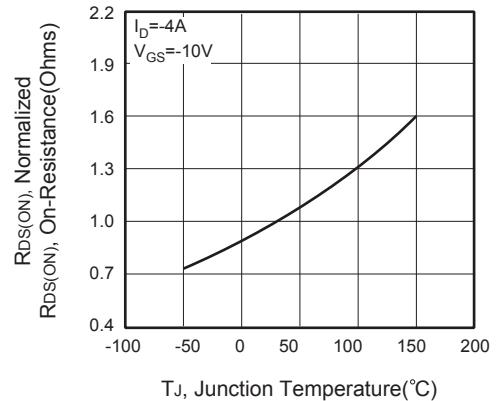
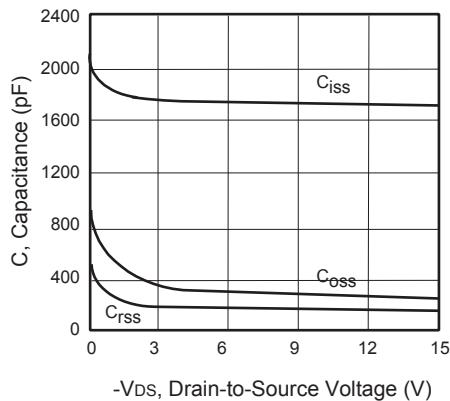
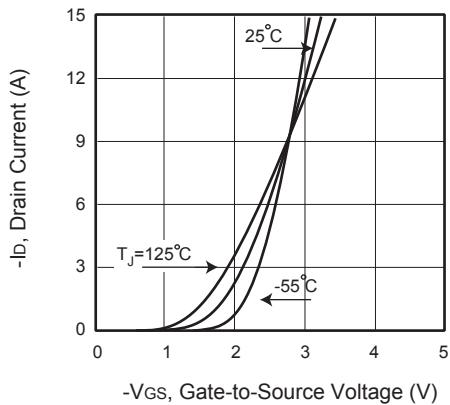


Figure 1. Output Characteristics



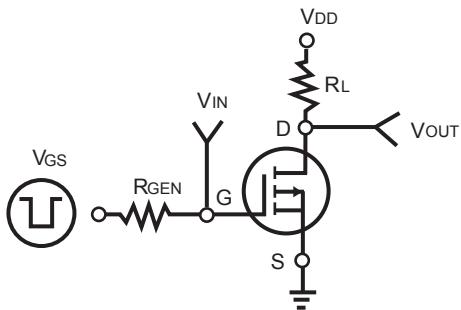
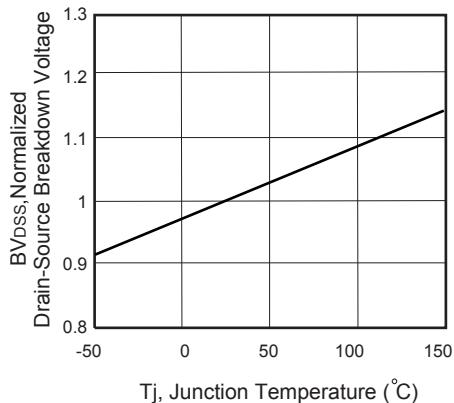
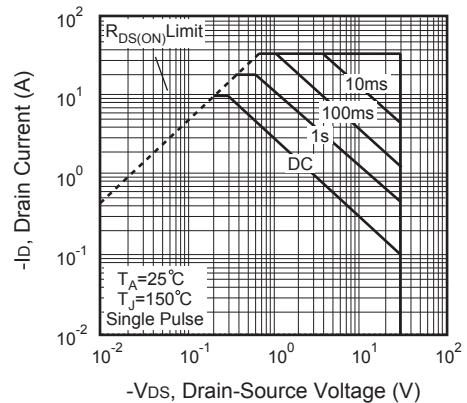
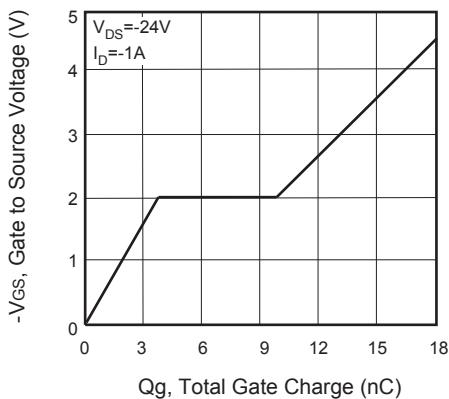
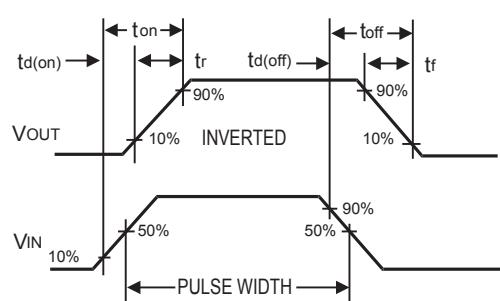


Figure 10. Switching Test Circuit



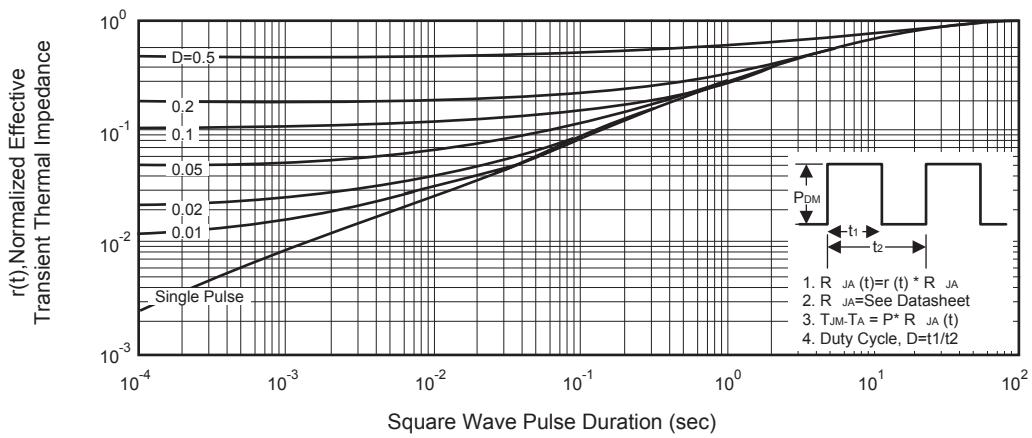


Figure 12. Normalized Thermal Transient Impedance Curve